



60V N-Channel Trench Power MOSFET

General Description

The SJS2310A uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a wide variety of applications.

Features

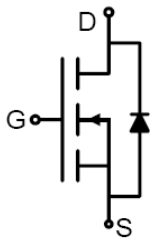
- Low Gate Charge
- High Power and current handling capability
- Lead free product is acquired

Application

- PWM Applications
- Load Switch
- Power Management

Key Performance Parameters

| Parameter | Value | Unit |
|-------------------|-------|------------|
| V_{DS} | 60 | V |
| $R_{DS(ON_TYP)}$ | 62.5 | m Ω |
| I_D | 3 | A |
| Q_G | 9 | nC |



Schematic Diagram



SOT-23 top view



Package Marking and Ordering Information

| Device/Ordering Code | Marking | Package | Packing | Reel Size | Tape width | Quantity |
|----------------------|---------|---------|---------|-----------|------------|----------|
| SJS2310A | 2310A | SOT-23 | Tape | \ | \ | 3000 Pcs |

Table 1. Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Limit | Unit |
|------------------|--|------------|------------------|
| V_{DS} | Drain-Source Voltage ($V_{GS}=0V$) | 60 | V |
| V_{GS} | Gate-Source Voltage ($V_{DS}=0V$) | ± 20 | V |
| I_D | Drain Current-Continuous($T_A=25^\circ\text{C}$) | 3 | A |
| | Drain Current-Continuous($T_A=100^\circ\text{C}$) | 1.9 | A |
| I_{DM} (pluse) | Drain Current-Continuous@ Current-Pulsed (Note 1) | 12 | A |
| P_D | Maximum Power Dissipation($T_A=25^\circ\text{C}$) | 1.5 | W |
| | Maximum Power Dissipation($T_A=100^\circ\text{C}$) | 0.6 | W |
| E_{AS} | Avalanche energy (Note 2) | 12 | mJ |
| T_J, T_{STG} | Operating Junction and Storage Temperature Range | -55 To 150 | $^\circ\text{C}$ |

Table 2. Thermal Characteristic

| Symbol | Parameter | Typ | Max | Unit |
|-----------------|---|-----|-----|--------------------|
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | | 83 | $^\circ\text{C/W}$ |



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Table 3. Electrical Characteristics ($T_J=25^{\circ}\text{C}$ unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|------------------------------------|-----------------------------------|--|-----|------|-------|------|
| On/Off States | | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V I _D =250μA | 60 | | | V |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} =60V, V _{GS} =0V T _J =25°C | | | 1 | μA |
| | | V _{DS} =60V, V _{GS} =0V T _J =125°C | | | 100 | μA |
| I _{GSS} | Gate-Body Leakage Current | V _{GS} =±20V, V _{DS} =0V | | | ±100 | nA |
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} =V _{GS} , I _D =250μA | 1 | | 2.5 | V |
| g _{FS} | Forward Transconductance | V _{DS} =5V, I _D =2A | | 4.1 | | S |
| R _{DS(ON)} | Drain-Source On-State Resistance | V _{GS} =10V, I _D =2A T _J =25°C | | 62.5 | 78.1 | mΩ |
| R _{DS(ON)} | Drain-Source On-State Resistance | V _{GS} =4.5V, I _D =1.5A T _J =25°C | | 75.8 | 100.8 | mΩ |
| Dynamic Characteristics | | | | | | |
| C _{iss} | Input Capacitance | V _{DS} =30V,V _{GS} =0V, f=1.0MHz | | 369 | | pF |
| C _{oss} | Output Capacitance | | | 28 | | pF |
| C _{rss} | Reverse Transfer Capacitance | | | 22 | | pF |
| R _g | Gate resistance | V _{GS} =0V, V _{DS} =0V, f=1.0MHz | | 0.78 | | Ω |
| Switching Parameters | | | | | | |
| t _{d(on)} | Turn-on Delay Time | V _{GS} =10V, V _{DS} =30V, R _L =15Ω, R _{GEN} =3Ω | | 5 | | nS |
| t _r | Turn-on Rise Time | | | 8 | | nS |
| t _{d(off)} | Turn-Off Delay Time | | | 36 | | nS |
| t _f | Turn-Off Fall Time | | | 21 | | nS |
| Q _g | Total Gate Charge | V _{GS} =10V, V _{DS} =30V, I _D =2A | | 9 | | nC |
| Q _{gs} | Gate-Source Charge | | | 1.6 | | nC |
| Q _{gd} | Gate-Drain Charge | | | 2 | | nC |
| Source-Drain Diode Characteristics | | | | | | |
| I _{SD} | Source-Drain Current (Body Diode) | | | | 3 | A |
| V _{SD} | Forward on Voltage (Note 3) | V _{GS} =0V, I _S =2A | | | 1.2 | V |
| t _{rr} | Reverse Recovery Time | I _F =2A, dI/dt=100A/μs | | 20 | | ns |
| Q _{rr} | Reverse Recovery Charge | I _F =2A, dI/dt=100A/μs | | 8 | | nC |

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

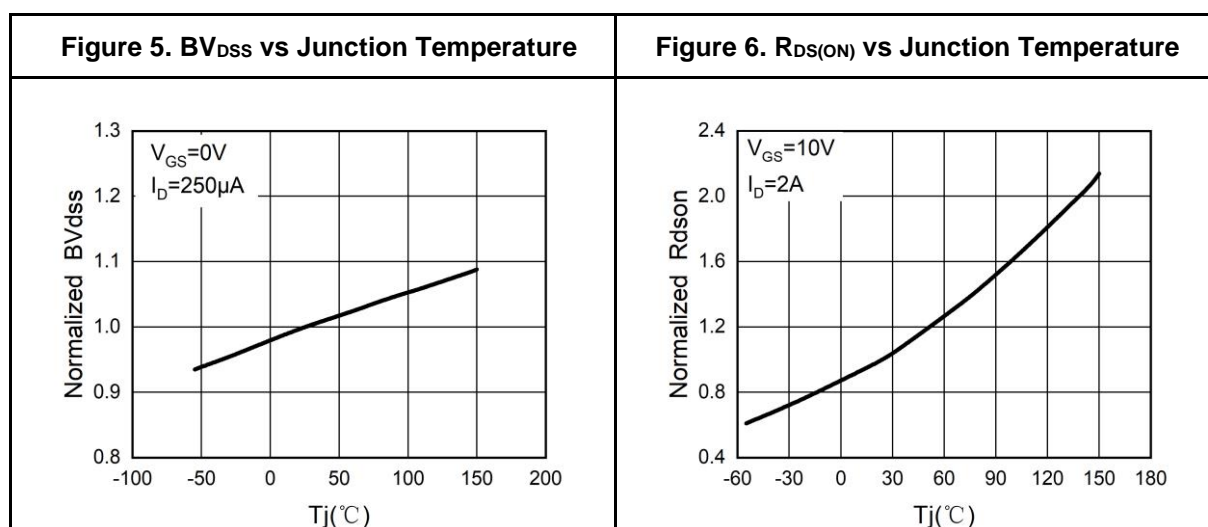
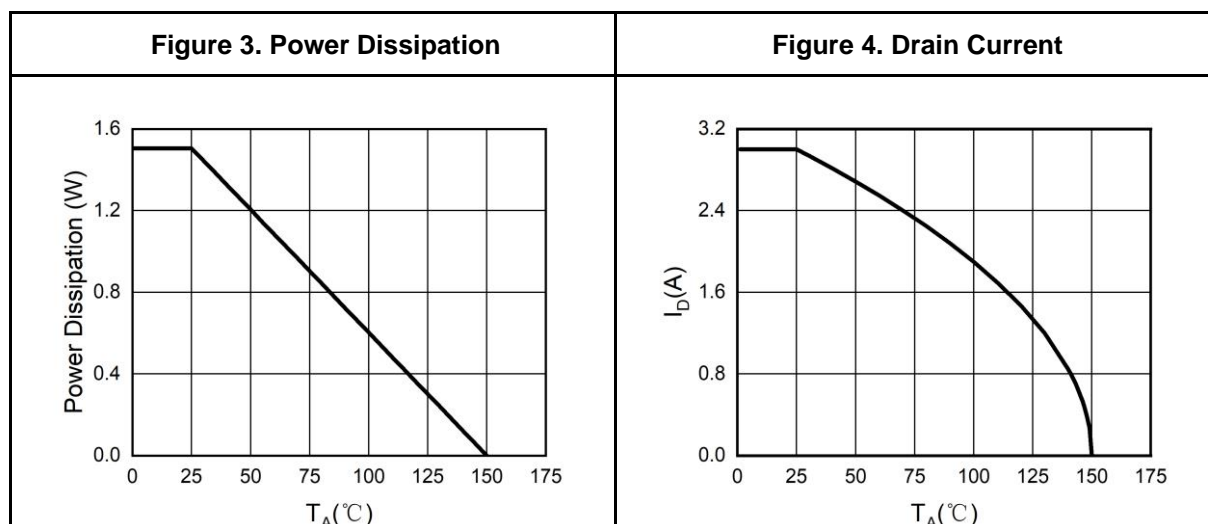
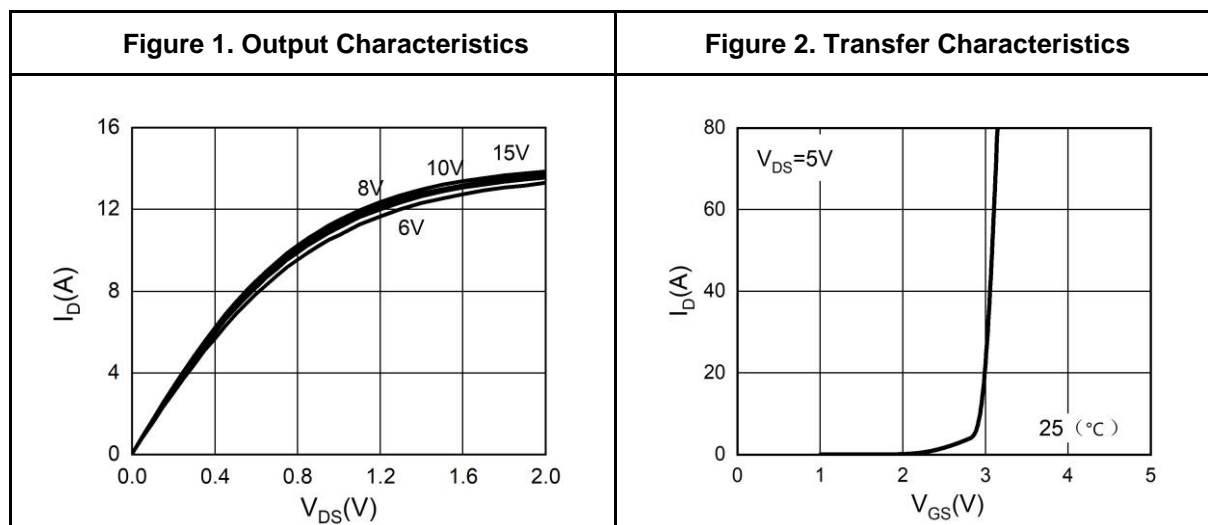
Notes 2.EAS condition: $T_J=25^{\circ}\text{C}, V_{DD}=40V, V_G=10V, R_g=25\Omega, L=0.5\text{mH}$.

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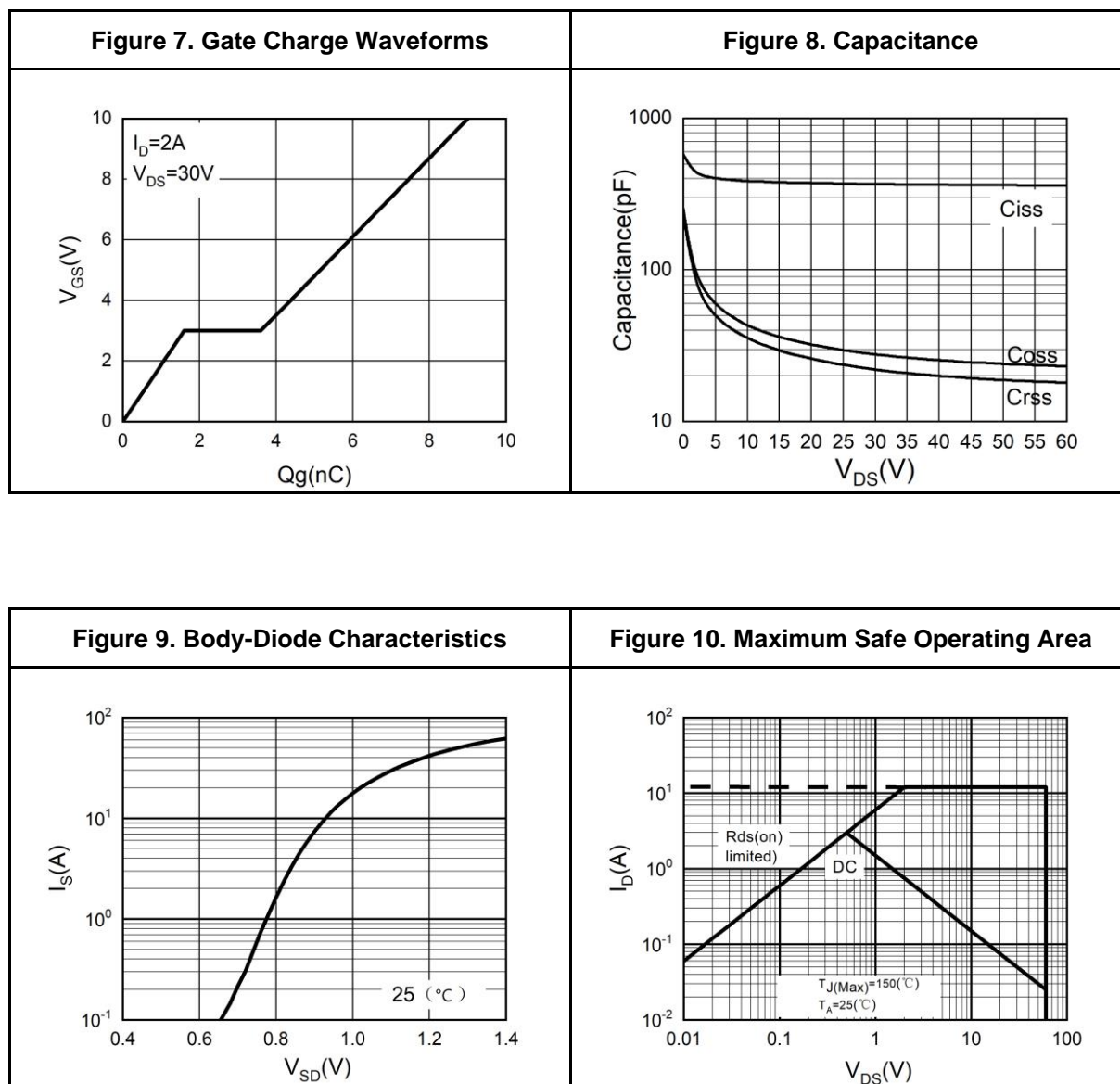
Typical Electrical And Thermal Characteristics (Curves)





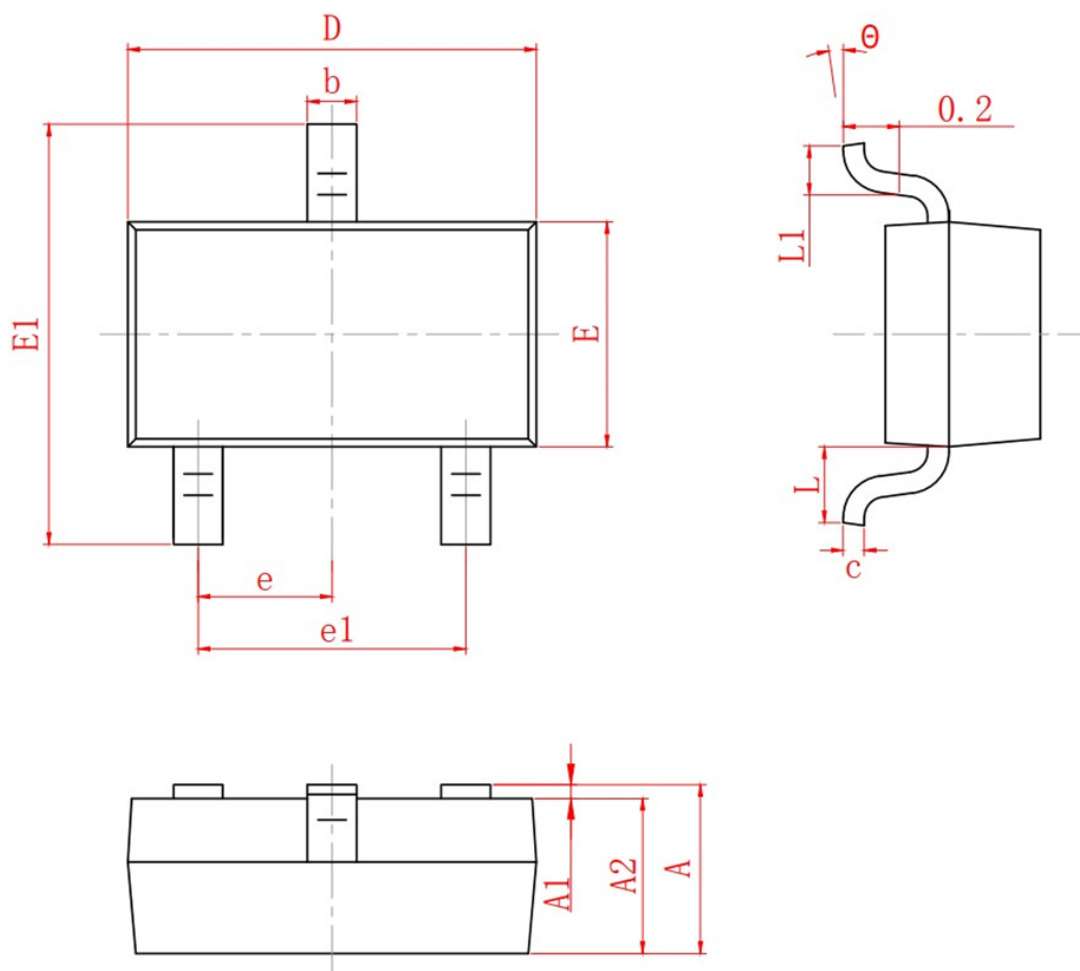
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Typical Electrical And Thermal Characteristics (Curves)





SOT-23 Package Information



| SYMBOL | MIN | NOM | MAX |
|----------|----------|------|------|
| A | 0.90 | 1.05 | 1.20 |
| A1 | 0.00 | 0.05 | 0.10 |
| A2 | 0.90 | 1.00 | 1.10 |
| b | 0.30 | 0.40 | 0.50 |
| c | 0.08 | 0.10 | 0.15 |
| D | 2.80 | 2.90 | 3.00 |
| E | 1.20 | 1.30 | 1.40 |
| E1 | 2.30 | 2.40 | 2.50 |
| L | 0.30 | 0.40 | 0.50 |
| θ | 0° | 5° | 10° |
| L1 | 0.55 REF | | |
| e | 0.95 BSC | | |
| e1 | 1.90 REF | | |



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